



FDP44N25 / FDPF44N25T **250V N-Channel MOSFET**

Features

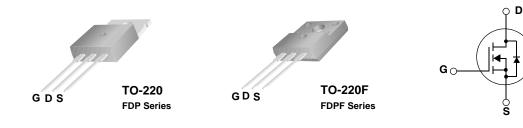
- 44A, 250V, $R_{DS(on)} = 0.069\Omega @V_{GS} = 10 V$ Low gate charge (typical 47 nC)
- Low Crss (typical 60 pF)
- Fast switching
- Improved dv/dt capability



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



Absolute Maximum Ratings

Symbol		Parameter	FDP44N25	FDPF44N25T	Unit	
V _{DSS}	Drain-Source Voltage				V	
Ι _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)			44 44* 26.4 26.4*	
I _{DM}	Drain Current	- Pulsed	(Note 1)	176	176*	А
V _{GSS}	Gate-Source voltage	e	-	V		
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	2055		mJ
I _{AR}	Avalanche Current		(Note 1)	44		А
E _{AR}	Repetitive Avalanche Energy		(Note 1)	30.7		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3		(Note 3)	4.5		V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		307 2.45	38 0.3	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			:	°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FDP44N25	FDPF44N25T	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	0.41	3.3	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

Package	e Mark	ing and Orde	ring In	formation	on					
Device Marking Device		Package		Reel Size	Tape Width			Quantity		
FDP44N25 FDP44N25		тс	D-220 -		-		50			
FDPF44N25T FDPF44N25T		TO	-220F	-		-		50		
Electric	al Cha	racteristics T	= 25°C unle	ss otherwise not	ied					
Symbol		Parameter		Conditions			Min	Тур	Max	Units
Off Charac	teristics									
BV _{DSS}	Drain-Sou	urce Breakdown Volta	ige	$V_{GS} = 0V,$	I _D = 250μA, T _J = 25°C		250			V
ΔBV_{DSS} / ΔT_{J}	Breakdow Coefficier	vn Voltage Temperatu nt	re	$I_D = 250 \mu A$, Referenced to 25°C				0.25		V/°C
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 250V, V_{GS} = 0V$ $V_{DS} = 200V, T_{C} = 125^{\circ}C$					1 10	μΑ μΑ	
I _{GSSF}	Gate-Bod	ly Leakage Current, F	orward	$V_{GS} = 30V$	$V, V_{\rm DS} = 0V$				100	nA
I _{GSSR}	Gate-Bod	ly Leakage Current, F	Reverse	$V_{GS} = -30V, V_{DS} = 0V$					-100	nA
On Charac	teristics									•
V _{GS(th)}	Gate Thre	eshold Voltage		$V_{DS} = V_{GS}$, I _D = 250μA		3.0		5.0	V
R _{DS(on)}		tic Drain-Source -Resistance		V _{GS} = 10V, I _D = 22A			0.058	0.069	Ω	
9 _{FS}	Forward ⁻	Transconductance		$V_{DS} = 40V$, I _D = 22A	(Note 4)		32		S
Dynamic C	haracteris	stics								
C _{iss}	Input Cap	ut Capacitance		$V_{DS} = 25V, V_{GS} = 0V,$			2210	2870	pF	
C _{oss}	Output Capacitance		f = 1.0MHz			450	585	pF		
C _{rss}	Reverse Transfer Capacitance							60	90	pF
Switching	Character	istics		-						
t _{d(on)}	Turn-On Delay Time		$V_{DD} = 125V, I_D = 44A$			53	117	ns		
t _r	Turn-On I	n Rise Time ff Delay Time		$R_{G} = 25\Omega$			402	814	ns	
t _{d(off)}	Turn-Off I						85	179	ns	
t _f	Turn-Off I	Fall Time			(Note 4, 5)			112	234	ns
Qg	Total Gate	e Charge			V, I _D = 44A			47	61	nC
Q _{gs}	Gate-Sou	e-Source Charge e-Drain Charge		V _{GS} = 10V (Note 4, 5)			18		nC	
Q _{gd}	Gate-Dra						24		nC	
	ce Diode	Characteristics and	Maximun	n Ratings						
I _S	I _S Maximum Continuous Drain-Source Dioc			de Forward (Current				44	Α
I _{SM}	Maximum	Pulsed Drain-Source	e Diode Fo	orward Curre	ent				176	Α
V _{SD}	Drain-Sou	urce Diode Forward V	oltage	$V_{GS} = 0V, I_{S} = 44A$					1.4	V
t _{rr}	Reverse	Recovery Time			$V_{GS} = 0V, I_{S} = 44A$			195		ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt =100A/μs (Note 4)			1.8		μC	

Notes:

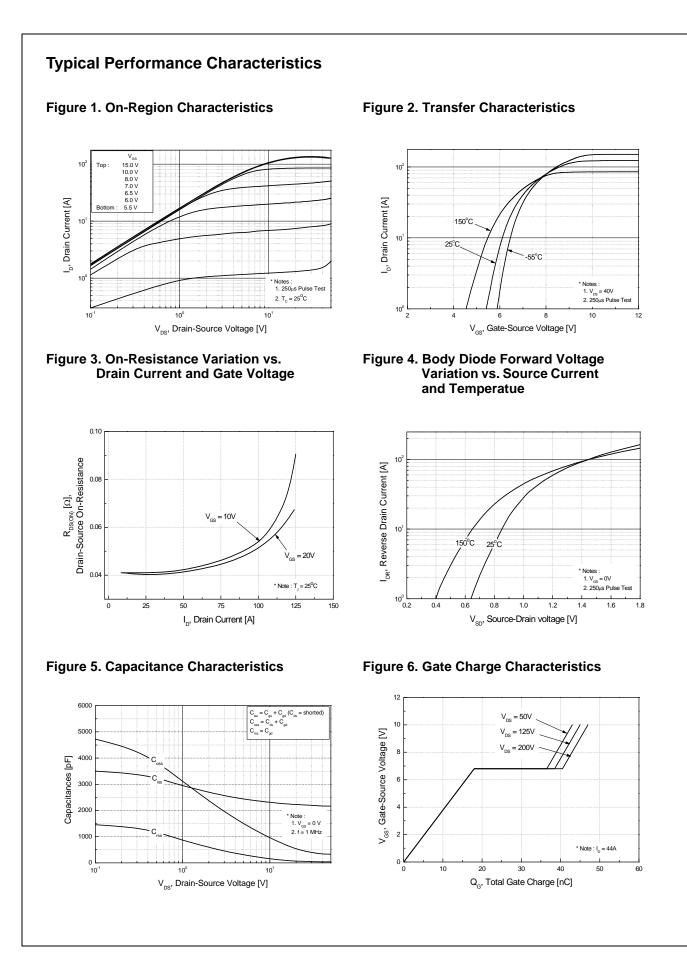
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 1.7mH, I_{AS} = 44A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

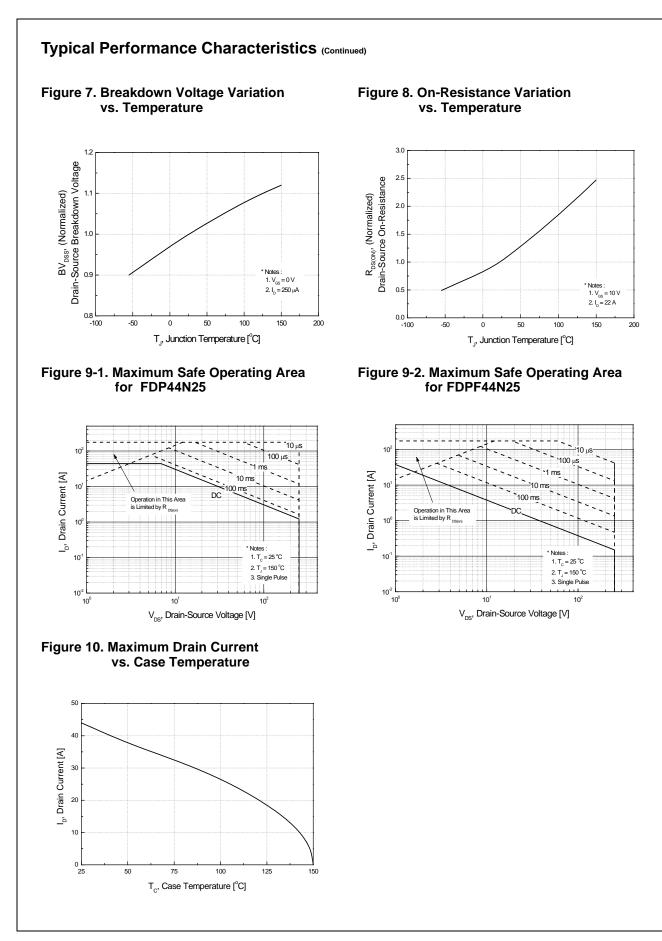
3. $I_{SD} \leq 44A, \, di/dt \leq 200A/\mu s, \, V_{DD} \leq BV_{DSS}, \, Starting \, T_J$ = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics



FDP44N25 / FDPF44N25T Rev. B



Typical Performance Characteristics (Continued)



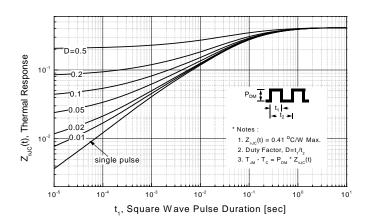
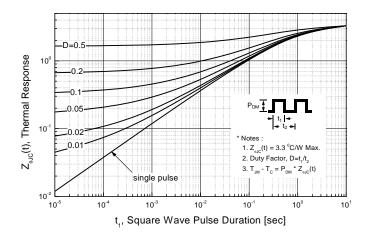
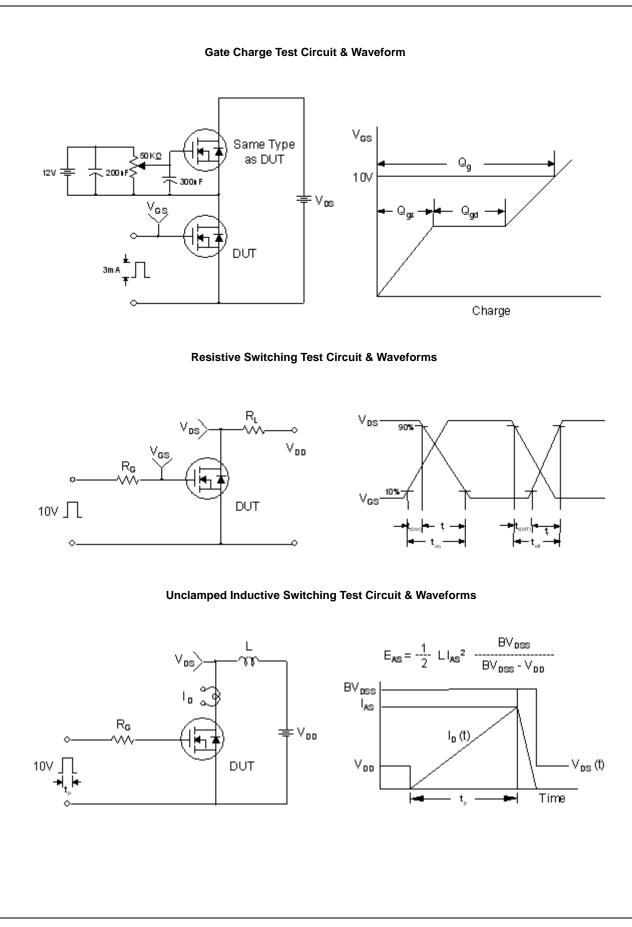


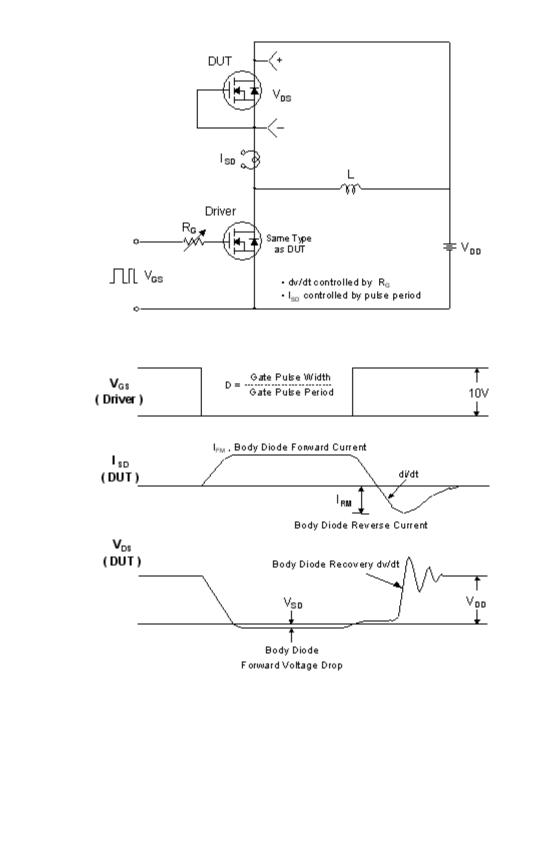
Figure 11-2. Transient Thermal Response Curve for FDPF44N25

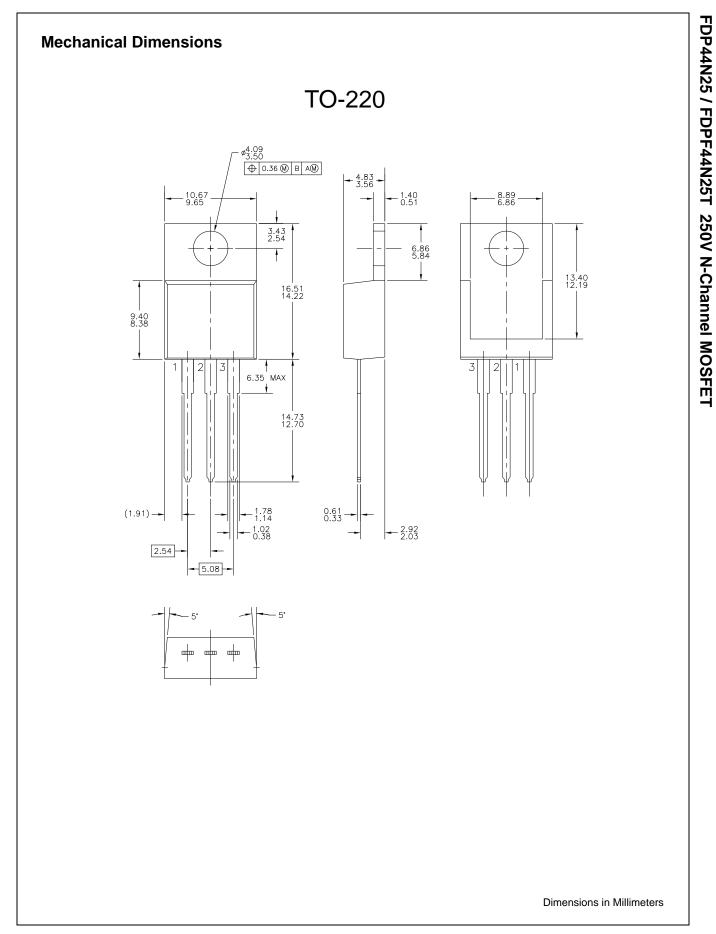


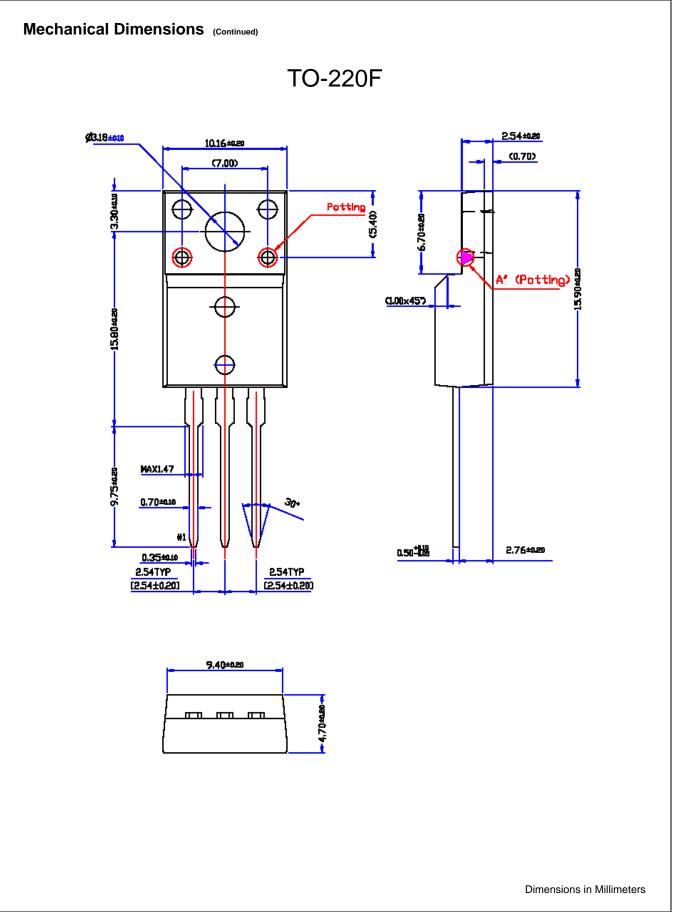


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